High Pass Filter

50Ω 4900 to 5850 MHz

Features

- Miniature size 0202 (0.026"[0.65mm] x 0.020"[0.5mm] x 0.015"[0.37mm])
- Low Insertion Loss, 0.4 dB typ.
- · Low cost
- · Aqueous washable

HPSC-492R+



CASE STYLE: SC0202C

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Applications

- ISM Band
- WLAN
- Bluetooth
- Zigbee

Electrical Specifications at 25°C

Pa	arameter	Frequency (MHz) Min.		Тур.	Max.	Unit	
Pass Band	Insertion Loss ¹	4900 - 5850	_	0.4	0.65	dB	
Pass Ballu	VSWR	4900 - 5850	_	1.2	2.0	:1	
Stop Band	Dejection Loss	500 - 2400	_	25	_	dB	
Stop Band	Rejection Loss	2400 - 2500	20	34	_		

^{1.} Tested on Evaluation Board TB-1029+

Block Diagram



Pad Connections

1

3.4

Input Output

Ground

Maximum Ratings

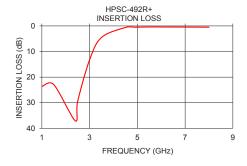
Operating Temperature	-40°C to 85°C
Storage Temperature ²	-40°C to 85°C
RF Power Input ³	2W at 25°C

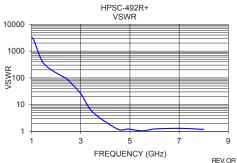
^{2.} Refer to product storage temperature after installation Suggestion for T&R unused product storage condition: +5 ~ +35 °C, Humidity 45~75%RH, 12 month Max

Typical Performance Data at 25°C4

Frequency (GHz)	Insertion Loss (dB)	VSWR (:1)
0.50	28.43	1801.42
1.00	23.69	3371.52
1.50	22.93	342.70
2.40	37.06	96.25
2.50	29.47	80.87
3.00	13.24	25.53
3.50	4.50	5.15
4.50	0.61	1.22
4.90	0.51	1.23
5.00	0.48	1.20
5.50	0.40	1.05
5.90	0.41	1.20
6.00	0.41	1.24
7.00	0.44	1.30
8.00	0.49	1.19

 $^{{\}it 4. \,\, Measured \,\, with \,\, Agilent \,\, E5071B \,\, network \,\, analyzer \,\, using \,\, impedance \,\, conversion \,\, and \,\, port \,\, extension.}$





Mini-Circuits

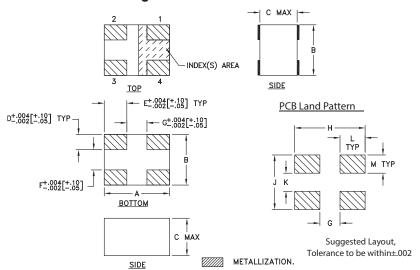
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^{3.} Derate linearly to 1W at 85°C

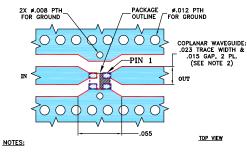
High Pass Filter

HPSC-492R+

Outline Drawing



Evaluation Board MCL P/N: TB-1029+ Suggested PCB Layout (PL-567)



- 1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
 2. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR FR4
 WITH DIELECTRIC THICKNESS. 0.09 **. 0.00 **. 0.00 FER: 1/2 OZ.
 FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
 3. LAYER 3 AND LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANES.
- 3. LAYER 3 AND LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANES.

 DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
 - DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Outline Dimensions (inch)

G	F	E	D	C	B	A
. 008	.008	. 009	. 006	. 015	. 020	. 026
0.20	0.20	0.23	0.15	0.38	0.51	0.66
wt		M	L	K	J	H
grams		0.007	.010	. 007	. 021	. 028
0.0005		0.18	0.25	0.18	0.53	0.71

Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

